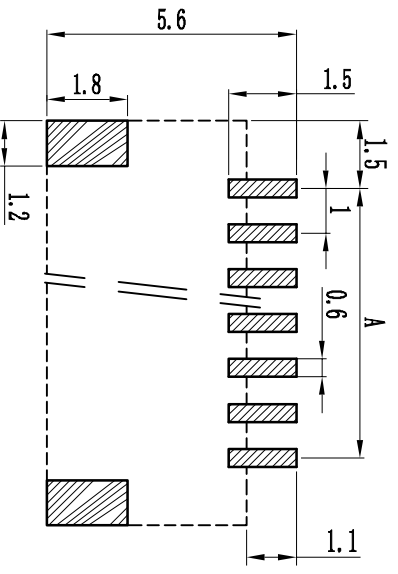


SPECIFICATION

1.Material:
Housing: HIGH-TEMP Plastic,UL94V-0,color:Natural.
Contacts: Copper alloy.
Solder tab: Copper alloy.

2.Electrical Characteristics:
Current rating: 0.5A(max).
Voltage rating: 150V(max).
Operating Temperature: -25°C~+85°C.
Insulation resistance: 1000M ohms min. at 800V DC
Dielectric withstanding voltage: 800V AC/minute.
Contact resistance: 30m ohms max.

孔数 pins	A	B	C
2	1	4	2.4
3	2	5	3.4
4	3	6	4.4
5	4	7	5.4
6	5	8	6.4
7	6	9	7.4
8	7	10	8.4
9	8	11	9.4
10	9	12	10.4
11	10	13	11.4
12	11	14	12.4
13	12	15	13.4
14	13	16	14.4
15	14	17	15.4
16	15	18	16.4
17	16	19	17.4
18	17	20	18.4
19	18	21	19.4
20	19	22	20.4



PCB Layout

UNITS: mm	CSCONN		CSCONN PRECISE ELECTRONICS CO.,LTD	
GENERAL TOLERANCE	PART NO. (INTENDED USE)	TITLE:	WAFER 1.0MM XP 贴片	
X. ° ±5° 0.X ±0.25	CMP-10XXW-T	DWG NO.	WAFER	
X.1 ±2° 0.XX ±0.2	APPD:	SCALE	SHEET	REV
XX. ±1° 0.XXX ±0.1	CHKD: Skila	1:1	1 OF 1	A
	DR: Kitty			